504520314 08/25/2017

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT4567019 Stylesheet Version v1.2

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
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HAJIME MATSUDA	08/10/2017

RECEIVING PARTY DATA

Name:	SUMITOMO ELECTRIC DEVICE INNOVATIONS, INC.
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State/Country:	JAPAN
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PROPERTY NUMBERS Total: 1

Property Type	Number		
Application Number:	15686755		

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ATTORNEY DOCKET NUMBER:	034519.025
NAME OF SUBMITTER:	MICHAEL A. MAKUCH
SIGNATURE:	/Michael A. Makuch/
DATE SIGNED:	08/25/2017

Total Attachments: 2

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PATENT 504520314 REEL: 043405 FRAME: 0015

<u>ASSIGNMENT</u>

This assignment agreement is applicable to an invention entitled

PROCESS OF FORMING NITRIDE SEMICONDUCTOR LAYERS

The PATENT PROPERTY referred to in this agreement is: (check one)	
a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.	
U.S. Patent Application Serial No, filed(date).	
a U.S. Patent Application based on PCT International Application No. filed (date) (U.S. Application Serial No. if known).	i on
U.S. Patent No, issued(date).	
*patents and patent applications identified above.	
The PATENT PROPERTY assigned under this agreement is: (check one)	
☑ U.S. patent property only.	
Worldwide patent property. In this case, the ASSIGNEE shall have the right to claim the ber of the filing date of any U.S. or foreign patent application for this invention.	efit
The term ENTIRE PATENT RIGHTS identifies the following rights: the full and exclusive right to the invention; the entire right, title and interest in and to the PATENT PROPERTY; the right to sue and recover for any past infringement; and, the right to claim priority under 35 USC 119, 35 USC 120, or any other applications, based on any earlier patent applications for this invention.	ble
The ASSIGNOR(S) referred to in this agreement are identified on page 2 of this Assignment.	
The following ASSIGNEE is the recipient of the entire rights assigned herein:	igeriaji
SUMITOMO ELECTRIC DEVICE INNOVATIONS, INC.	***************************************
1, Kanai-cho, Sakae-ku	and in the second
Yokohama-shi, Kanagawa 244-0845	
JAPAN	

SGR/14674017.2

PATENT REEL: 043405 FRAME: 0016

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S)

THIS MODICIN	icc is.				
(check one)		An Individual.			
		A Partnership.			
	\boxtimes	A Corporation/Entity ofJAP	'AN	(specify state or co	u ntry)
		(other)			
consideration	, receip	in consideration of \$10.00 pale t of which is acknowledged, he PATENT RIGHTS.	d by the ASS reby assign t	IGNEE, and other to the ASSIGNEE,	good and valuable its successors and
and request t	he Com nee of	applications assigned under the missioner of Patents and Trade the right, title and interest, founds:	emarks to issu	ue all Letters Patent	to the ASSIGNEE
known to the lawful papers applications, to said ASSI	ASSIG s, execute execute GNEE,	OR(S) agree to communicate to NOR(S) respecting said invented all divisional, continuation all necessary assignment paper aske all rightful oaths and geroccessors and assigns, to obtain	ition, and test i, substitute, ers to cause a nerally do eve	tify in any legal pro renewal, reexamin any and all Letters F erything necessary	oceedings, sign all ation and reissue Patent to be issued or desirable to aid
application to	check	authorize any attorneys and any appropriate boxes and to been executed.	agents who o insert the S	i have a power o Serial Number and	of attorney in this filling date in this
Signature:	Tado	shi Watanabe		Date: August	10,2017
Name: <u>Tada</u>	shi WAT	ANABE			
Signature:	Haji	me MATSUBA	- 19 - 19 - 19 - 19 - 19 - 19 - 19 - 19	Date: August	[0, 2017
Name: <u>Flaiim</u>					

Signature:				Date:	
Bloomer					

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PATENT REEL: 043405 FRAME: 0017